

# NXM32-FC-SW

## SFP28G 850nm 100m Multimode

### Features

- SFP28 Form Factor
- 28,05 Gb/s bitrate
- Up to 100 m over Multimode
- LC connector
- 850 nm, VCSEL laser, PIN photodiode
- Up to 1W power consumption
- +0/+70°C temperature range
- Built in digital diagnostic monitoring



### Applications

- 32GBase Fibre Channel
- Access and Enterprise

### Optical specifications



**Optical budget : 6.3 dB**

### Transmitter & Receiver optical Specifications

Parameter	Min	Max	Unit
Tx Power	-6.7		dBm
Rx Sensitivity	-13	-1	dBm

## Regulatory Compliance

- ESD to the Electrical PINs: compatible with MIL-STD-883E Method 3015.4
- ESD to the LC Receptacle: compatible with IEC 61000-4-3
- EMI/EMC compatible with FCC Part 15 Subpart B Rules, EN55022:2010
- Laser Eye Safety compatible with FDA 21CFR, EN60950-1& EN (IEC) 60825-1,2
- RoHS compliant with EU RoHS 2.0 directive 2015/863/EU

## Absolute Maximum Ratings

Parameter	Symbol	Min.	Max.	Unit
Maximum Supply Voltage	V <sub>CC</sub>	0	3.6	V
Storage Temperature	T <sub>S</sub>	-40	85	°C
Operating Case Temperature	T <sub>C</sub>	0	70	°C
Operating Humidity	RH	5	85	%
Receiver Power	R <sub>MAX</sub>		-1	dBm
Maximum Bitrate	B <sub>max</sub>	8.5	28.05	Gbps

## Electrical Characteristics (TOP=25°C, V<sub>CC</sub>=3.3Volts)

Parameter		Symbol	Min.	Typ.	Max.	Unit	Notes
Power Supply Voltage		V <sub>CC</sub>	3.13	3.30	3.47	V	
Power Supply Current		I <sub>CC</sub>			300	mA	
Power Consumption		P <sub>DISS</sub>			1	W	
Transmitter							
Differential data input swing	28.05Gbps	V <sub>in,pp</sub>	50		900	mV	
	14.025Gbps & 8.5Gbps	V <sub>in,pp</sub>	180		700	mV	
Input differential impedance		Z <sub>in</sub>	90	100	110	Ω	
Receiver							
Differential data output swing		V <sub>out, pp</sub>	300		850	mV	
Output differential impedance		Z <sub>in</sub>	90	100	110	Ω	

## Optical Characteristics

Parameter		Symbol	Min.	Typ.	Max.	Unit	Notes
Transmitter							
Optical Power (average)	28.05Gbps	$P_{AVE}$	-6.7			dBm	1
	14.025Gbps	$P_{AVE}$	-7.8			dBm	1
	8.5Gbps	$P_{AVE}$	-6.7			dBm	1
Optical Modulation amplitude (OMA)	28.05Gbps	$P_{OMA}$	-3.2			dBm	2
	14.025Gbps	$P_{OMA}$	-4.8			dBm	2
	8.5Gbps	$P_{OMA}$	-5.2			dBm	2
Optical Extinction Ratio		ER	2			dB	
Optical Wavelength		$T\lambda$	840	850	860	nm	
Insertion loss		IL		2			
Receiver							
Receiver Sensitivity (average)		$R_{AVE}$			-13	dBm	3
Receiver Sensitivity (OMA)	28.05Gbps	$R_{OMA}$			-10.2	dBm	2
	14.025Gbps	$R_{OMA}$			-10.5	dBm	2
	8.5Gbps	$R_{OMA}$			-11.2	dBm	2
Receiver overload		$P_{max}$	-1			dBm	4
Receiver wavelength		$R\lambda$	840		860	nm	

### Notes:

1. Coupled into a Multi-mode fibre
2. Per IEEE 802.3ae specification
3. Average power, back-to-back, @10.31Gbps, BER 1E-12, PRBS 231-1.
4. Exceeding the Receiver overload can physically damage the module. Please use appropriate attenuation.

## Pin Descriptions

Pin	Symbol	Name/Descriptions	Ref.
1	VeeT	Transmitter Ground (Common with Receiver Ground).	1
2	TX Fault	Transmitter Fault. LVTTTL-O	2
3	TX Disable	Transmitter Disable. Laser output disabled on high or open. LVTTTL-I.	3
4	SDA	2-Wire Serial Interface Data Line (Same as MOD-DEF2 in INF-8074i). LVTTTL-I/O.	
5	SCL	2-Wire Serial Interface Data Line (Same as MOD-DEF2 in INF-8074i). LVTTTL-I.	
6	MOD_ABS	Module Absent, Connect to VeeT or VeeR in Module.	4
7	RS0	Rate Select 0. Not used	5
8	LOS	Loss of Signal indication. Logic 0 indicates normal operation. LVTTTL-O.	2
9	RS1	Rate Select 1. Not used	5
10	VeeR	Receiver Ground (Common with Transmitter Ground).	1
11	VeeR	Receiver Ground (Common with Transmitter Ground).	1
12	RD-	Receiver Inverted DATA out. AC Coupled. CML-O.	
13	RD+	Receiver Non-inverted DATA out. AC Coupled. CML-O.	
14	VeeR	Receiver Ground (Common with Transmitter Ground).	1
15	VccR	Receiver Power Supply.	
16	VccT	Transmitter Power Supply.	
17	VeeT	Transmitter Ground (Common with Receiver Ground).	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled. CML-I.	
19	TD-	Transmitter Inverted DATA in. AC Coupled. CML-O.	
20	VeeT	Transmitter Ground (Common with Receiver Ground).	1

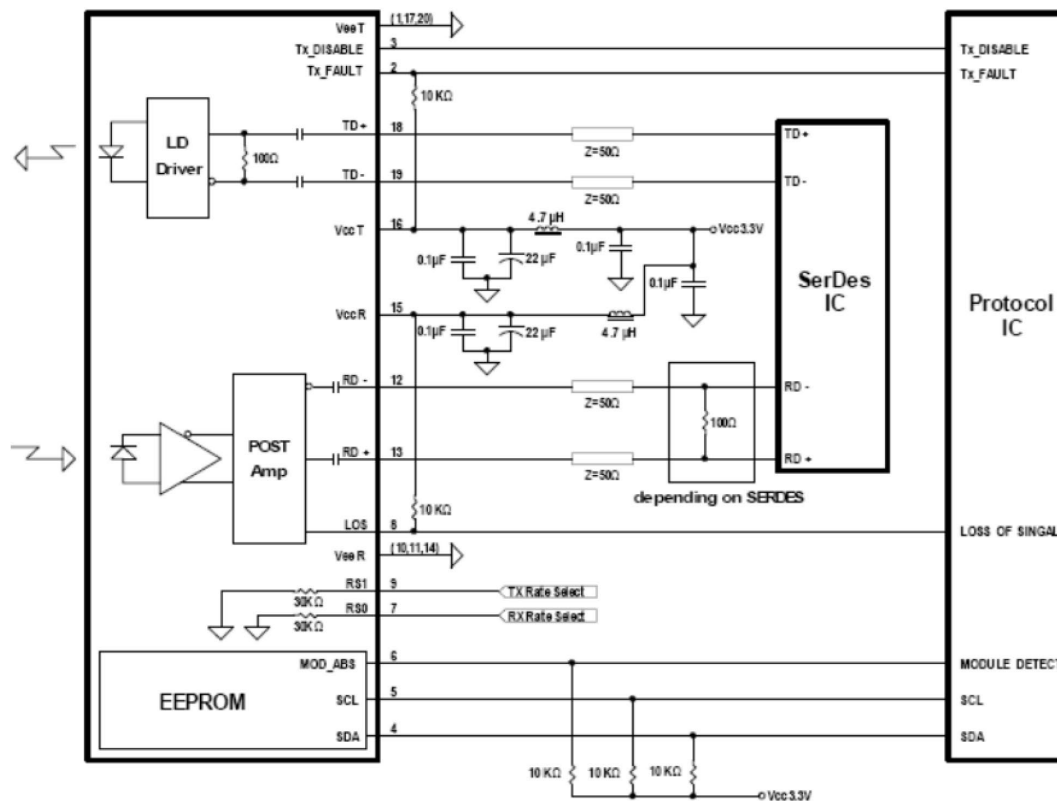
## Notes:

1. The module signal ground contacts, VeeR and VeeT, should be isolated from the module case.
2. This contact is an open collector/drain output and should be pulled up to the Vcc\_Host with resistor in the range 4.7KΩ to 10KΩ. Pull ups can be connected to one or several power supplies, however the host board design shall ensure that no module contract has voltage exceeding module VccT/R +0.5.V.
3. Tx\_Disable is an input contact with a 4.7KΩ to 10KΩ pull-up resistor to VccT inside module.
4. Mod\_ABS is connected to VeeT or VeeR in the SFP+ module. The host may pull the contract up to Vcc\_Host with a resistor in the range from 4.7KΩ to 10KΩ. Mod\_ABS is asserted “High” when the SFP+ module is physically absent from a host slot.
5. Internally pulled down per SFF-8431



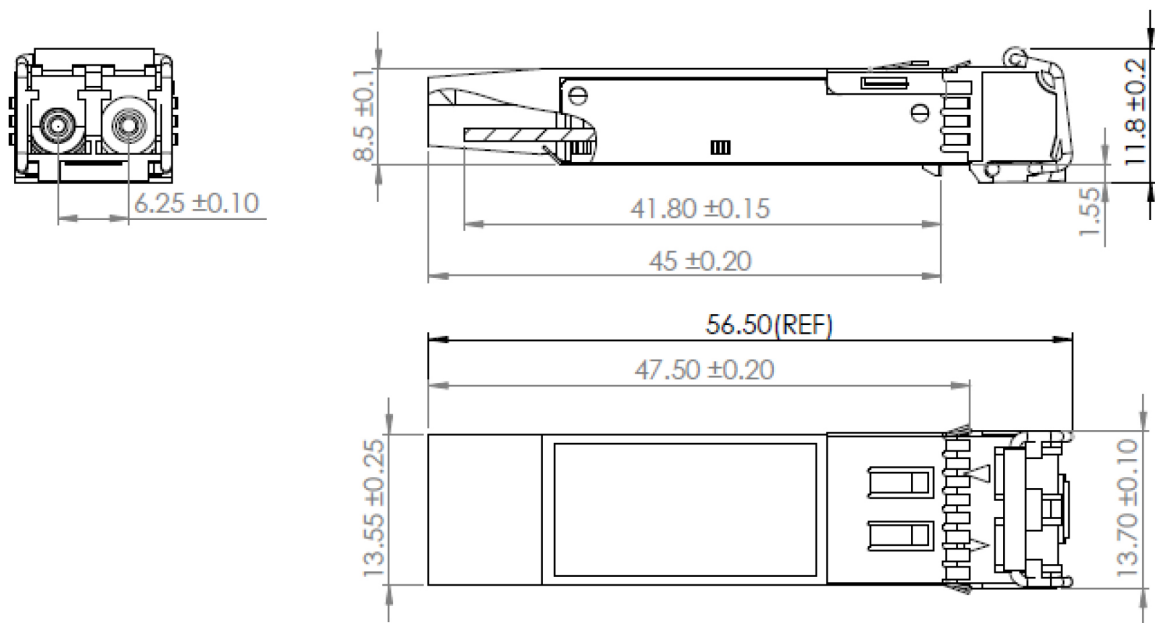
Pin-out of connector Block on Host board

### Recommended Circuit Schematic



**Mechanical Specifications**

Small Form Factor Pluggable (SFP) transceivers are compatible with the dimensions defined by the SFP Multi-Sourcing Agreement (MSA).



**EEPROM Information**

EEPROM memory map specific data field description is as below:

